

Electronic Patent Application Fee Transmittal

Application Number:	10594548
Filing Date:	27-Sep-2006
Title of Invention:	Heat-Resistant Photosensitive Resin Composition, Method For Forming Pattern Using the Composition, and Electronic Part
First Named Inventor/Applicant Name:	Hiroshi Komatsu
Filer:	William Ivan Solomon/Kelli Harris
Attorney Docket Number:	1270.46593X00

Filed as Large Entity

U.S. National Stage under 35 USC 371 Filing Fees

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Notice of appeal	1401	1	540	540
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension - 2 months with \$0 paid	1252	1	490	490
Miscellaneous:				
Total in USD (\$)				1030